

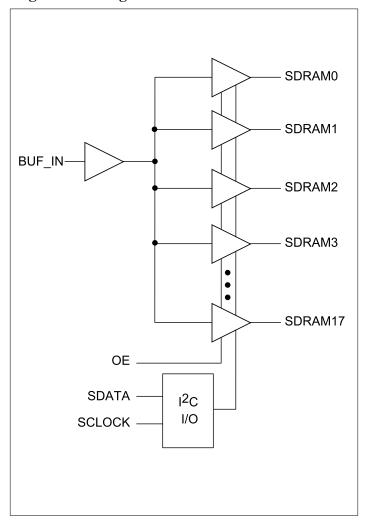


## Precision 1-18 Clock Buffer

#### **Product Features**

- High-speed, to 125 MHz (PI6C180A)
- Low-noise non-inverting 1-18 buffer
- Supports up to four SDRAM DIMMs
- Low skew (< 250ps) between any two output clocks
- I<sup>2</sup>C Serial Configuration interface
- Multiple V<sub>DD</sub>, V<sub>SS</sub> pins for noise reduction
- 3.3V power supply voltage
- Separate Hi-Z pin for testing
- 48-pin SSOP package (V)

# Logic Block Diagram



### **Description**

The PI6C180 is a high-speed low-noise 1-18 noninverting buffer designed for SDRAM clock buffer applications.

PI6C180 can operate up to 100 MHz, whereas PI6C180A is rated at 125 MHz.

At power up all SDRAM output are enabled and active. The I<sup>2</sup>C Serial control may be used to individually activate/deactivate any of the 18 output drivers.

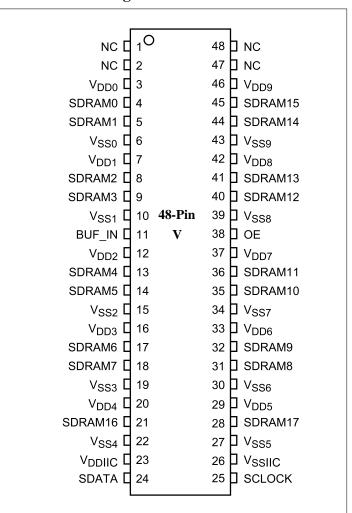
The output enable (OE) pin may be pulled low to put all outputs in a Hi-Z state.

#### Note:

1

Purchase of I<sup>2</sup>C components from Pericom conveys a license to use them in an I<sup>2</sup>C system as defined by Philips.

### **Product Pin Configuration**





# **Product Pin Description**

Pin	Symbol	Туре	Qty	Description
4,5,8,9	SDRAM[0-3]	О	4	SDRAM Byte 0 clock output
13,14,17,18	SDRAM[4-7]	О	4	SDRAM Byte 1 clock output
31,32,35,36	SDRAM[8-11]	О	4	SDRAM Byte 2 clock output
40,41,44,45	SDRAM[12-15]	О	4	SDRAM Byte 3 clock output
21,28	SDRAM[16-17]	О	4	SDRAM clock outputs usable for feedback
11	BUF_IN	I	1	Input for 1-18 buffer
38	OE	I	1	Hi-Z all outputs when held LOW. Has a $> 100 k\Omega$ internal pull-up resistor
24	SDATA	I/O	1	Data pin for $I^2C$ circuitry. Has a $>100k\Omega$ internal pull-up resistor
25	SCLOCK	I/O	1	Clock pin $I^2C$ circuitry. Has a $>100k\Omega$ internal pull-up resistor
3,7,12,16,20, 29,33,37,42,46	V <sub>DD[0-9</sub> ]	Power	10	3.3V power supply for SDRAM buffers
6,10,15,19,22, 27,30,34,39,43	V <sub>SS[0-9]</sub>	Ground	10	Ground for SDRAM buffers
23	V <sub>DDIIC</sub>	Power	1	3.3V power supply for I <sup>2</sup> C circuitry
26	V <sub>SSIIC</sub>	Ground	1	Ground for I <sup>2</sup> C circuitry
1,2,47,48	NC	Reserved	4	Reserved for future modification. No connects

# **OE** Functionality

OE	SDRAM[0-17]	Note
0	Hi-Z	1
1	BUF_IN	2

## **Notes:**

- 1. Used for test purposes only
- 2. Buffers are non-inverting

# PI6C180 I<sup>2</sup>C Address Assignment

<b>A6</b>	A5	A4	A3	A2	A1	A0	R/W
1	1	0	1	0	0	1	0

# PI6C180 Serial Configuration Map

Byte0: SDRAM Active/Inactive Register (1 = enable, 0 = disable)

Bit	Pin#	Description
Bit 7	18	SDRAM7 (Active/Inactive)
Bit 6	17	SDRAM6 (Active/Inactive)
Bit 5	14	SDRAM5 (Active/Inactive)
Bit 4	13	SDRAM4 (Active/Inactive)
Bit 3	9	SDRAM3 (Active/Inactive)
Bit 2	8	SDRAM2 (Active/Inactive)
Bit 1	5	SDRAM1 (Active/Inactive)
Bit 0	4	SDRAM0 (Active/Inactive)

2

#### Note:

Inactive means outputs are held LOW and are disabled from switching.



# 2-Wire I<sup>2</sup>C Control

The I<sup>2</sup>C interface permits individual enable/disable of each clock output and test mode enable.

The PI6C180 is a slave receiver device. It can not be read back. Sub addressing is not supported. All preceding bytes must be sent in order to change one of the control bytes.

Every bite put on the SDATA line must be 8-bits long (MSB first), followed by an acknowledge bit generated by the receiving device. During normal data transfers SDATA changes only when SCLOCK is LOW. Exceptions: A HIGH to LOW transition on SDATA while SCLOCK is HIGH indicates a "start" condition. A LOW to HIGH transition on SDATA while SCLOCK is HIGH is a "stop" condition and indicates the end of a data transfer cycle.

Byte1: SDRAM Active/Inactive Register (1 = enable, 0 = disable)

Bit	Pin#	Description
Bit 7	45	SDRAM15 (Active/Inactive)
Bit 6	44	SDRAM14 (Active/Inactive)
Bit 5	41	SDRAM13 (Active/Inactive)
Bit 4	40	SDRAM12 (Active/Inactive)
Bit 3	36	SDRAM11 (Active/Inactive)
Bit 2	35	SDRAM10 (Active/Inactive)
Bit 1	32	SDRAM9 (Active/Inactive)
Bit 0	31	SDRAM8 (Active/Inactive)

Each data transfer is initiated with a start condition and ended with a stop condition. The first byte after a start condition is always a 7-bit address byte followed by a read/write bit. (HIGH = read from addressed device, LOW= write to addressed device). If the device's own address is detected, PI6C180 generates an acknowledge by pulling SDATA line LOW during ninth clock pulse, then accepts the following data bytes until another start or stop condition is detected.

Following acknowledgement of the address byte (D2), two more bytes must be sent:

- 1. "Command Code" byte, and
- 2. "Byte Count" byte.

Although the data bits on these two bytes are "don't care," they must be sent and acknowledged.

Byte2: Optional Register for Possible Future Requirements (1 = enable, 0 = disable)

Bit	Pin #	Description
Bit 7	28	SDRAM17 (Active/Inactive)
Bit 6	21	SDRAM16 (Active/Inactive)
Bit 5		(Reserved)
Bit 4		(Reserved)
Bit 3		(Reserved)
Bit 2		(Reserved)
Bit 1		(Reserved)
Bit 0		(Reserved)

### **Maximum Ratings**

(Above which the useful life may be impaired. For user guidelines, not tested.)

l	Storage Temperature65°C to +150°C
	Ambient Temperature with Power Applied $-0^{\circ}$ C to $+70^{\circ}$ C
	3.3V Supply Voltage to Ground Potential0.5V to +4.6V
	DC Input Voltage0.5V to +4.6V

#### Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

# Supply Current ( $V_{DD} = +3.465V$ , $C_{LOAD} = Max$ .)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
$I_{DD}$	Supply Current	BUF_IN = 0 MHz			3	
$I_{DD}$	Supply Current	BUF_IN = 66.66 MHz			230	mA
$I_{DD}$	Supply Current	BUF_IN = 100.0 MHz			360	

3



# DC Operating Specifications ( $V_{DD} = +3.3V \pm 5\%$ , $T_A = 0^{\circ}C - 70^{\circ}C$ )

Symbol	Parameter	Parameter Test Condition Min.		Max.	Units	
Input Volta	ge					
$V_{\mathrm{IH}}$	Input high voltage	V <sub>DD</sub>	2.0	V <sub>DD</sub> +0.3	v	
$V_{\mathrm{IL}}$	Input low voltage		V <sub>SS</sub> -0.3	0.8	V	
$I_{ m IL}$	Input leakage current	$0 < V_{IN} < V_{DD}$	-5	+5	mA	
V <sub>DD</sub> [0-9] =	3.3V ±5%					
V <sub>OH</sub>	Output high voltage	$I_{OH} = -1 \text{mA}$	2.4		V	
V <sub>OL</sub>	Output low voltage	$I_{OL} = 1 \text{mA}$		0.4	v	
C <sub>OUT</sub>	Output pin capacitance			6	"E	
C <sub>IN</sub>	Input pin capacitance			5	pF	
L <sub>PIN</sub>	Pin Inductance			7	nН	
TA	Ambient Temperature	No Airflow	0	70	°C	

# **SDRAM Clock Buffer Operating Specification**

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
I <sub>OHMIN</sub>	Pull-up current	$V_{OUT} = 2.0V$	-54			
I <sub>OHMAX</sub>	Pull-up current	$V_{OUT} = 3.135V$			-46	mA
I <sub>OLMIN</sub>	Pull-down current	$V_{OUT} = 1.0V$	54			
I <sub>OLMAX</sub>	Pull-down current	$V_{OUT} = 0.4V$			53	
t <sub>RH</sub> SDRAM	Output rise edge rate SDRAM only	3.3V ±5% @04V-2.4V	1.5		4	V/ns
t <sub>TH</sub> SDRAM	Output fall edge rate SDRAM only	3.3V ±5% @2.4V-0.4V	1.5		4	

# **AC Timing**

						PI6C	180A	
Symbol	Parameter	66 ]	66 MHz		100 MHz		133 MHz	
		Min.	Max.	Min.	Max.	Min.	Max.	
tSDKP	SDRAM CLK period	15.0	15.5	10.0	10.5	7.5	7.8	
t <sub>SDKH</sub>	SDRAM CLK high time	5.6		3.3		1.0		ns
t <sub>SDKL</sub>	SDRAM CLK low time	5.3		3.1		1.0	1.0	
t <sub>SDRISE</sub>	SDRAM CLK rise time	1.5	4.0	1.5	4.0	1.5		
tSDFALL	SDRAM CLK fall time	1.5	4.0	1.5	4.0	1.5	4.0	V/ns
tPLH	SDRAM Buffer LH prop delay	1.0	5.0	1.0	5.0	1.0	5.0	
t <sub>PHL</sub>	SDRAM Buffer HL prop delay	1.0	5.0	1.0	5.0	1.0	5.0	
tpZL,tpZH	SDRAM Buffer Enable delay	1.0	8.0	1.0	8.0	1.0	8.0	ns
t <sub>PLZ</sub> ,t <sub>PHZ</sub>	SDRAM Buffer Disable delay	1.0	8.0	1.0	8.0	1.0	8.0	
Duty Cycle	Measured at 1.5V	45	55	45	55	45	55	%
t <sub>SDSKW</sub>	SDRAM Output to Output Skew		250		250		250	ps



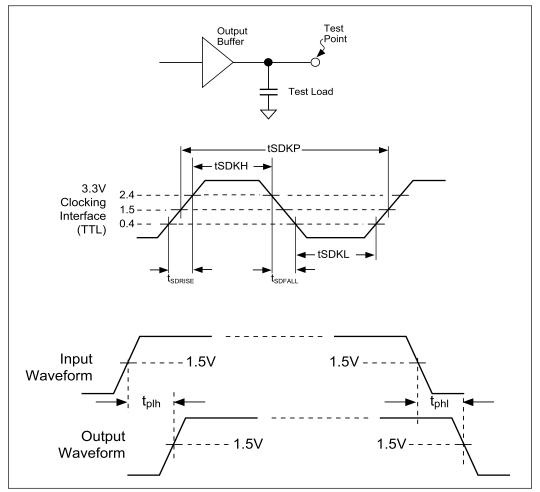


Figure 1. Clock Waveforms

## **Minimum and Maximum Expected Capacitive Loads**

Clock	Min. Load	Max. Load	Units	Notes
SDRAM	20	30	pF	SDRAM DIMM Specification

#### **Notes:**

- 1. Maximum rise/fall times are guaranteed at maximum specified load.
- 2. Minimum rise/fall times are guaranteed at minimum specified load.
- 3. Rise/fall times are specified with pure capacitive load as shown. Testing is done with an additional  $500\Omega$  resistor in parallel.

## **Design Guidelines to Reduce EMI**

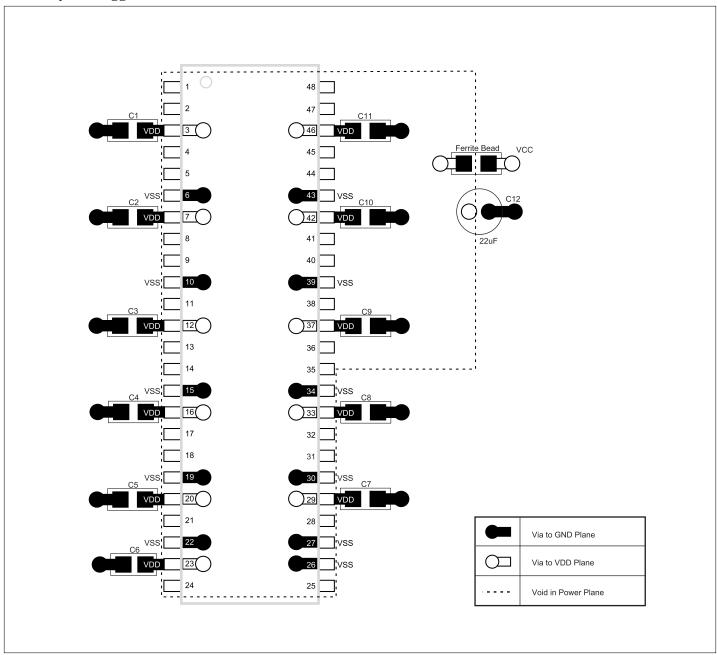
- 1. Place series resistors and CI capacitors as close as possible to the respective clock pins. Typical value for CI is 10pF. Series resistor value can be increased to reduce EMI provided that the rise and fall time are still within the specified values.
- 2. Minimize the number of "vias" of the clock traces.
- 3. Route clock traces over a continuous ground plane or over a continuous power plane. Avoid routing clock traces from plane to plane (refer to rule #2).

5

4. Position clock signals away from signals that go to any cables or any external connectors.



# **PCB Layout Suggestion**



#### Note

This is only a suggested layout. There may be alternate solutions depending on actual PCB design and layout.

As a general rule, C1-C11 should be placed as close as possible to their respective V<sub>DD</sub>.

Recommended capacitor values:

C1-C11 ...... 0.1µF, ceramic

C12 ...... 22µF

6



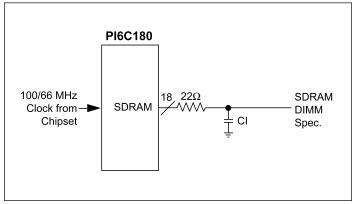
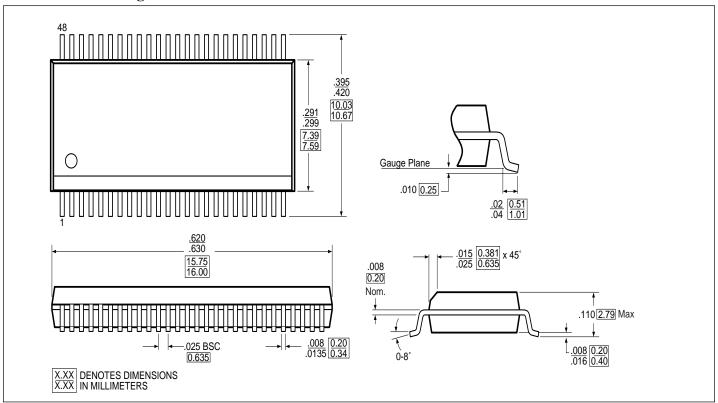


Figure 2. Design Guidelines

# 48-Pin SSOP Package Data



## **Table of Dimensions**

Body		E (Width)	D (Length)	A (Height)	e (Pin-to-Pin pitch)
48 pins	Min.	0.291	0.620	0.095	0.025
(300 mil)	Max.	0.299	0.630	0.110	-

# **Ordering Information**

P/N	Description		
PI6C180V	48-pin SSOP Package		
PI6C180AV	48-pin SSOP Package		

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